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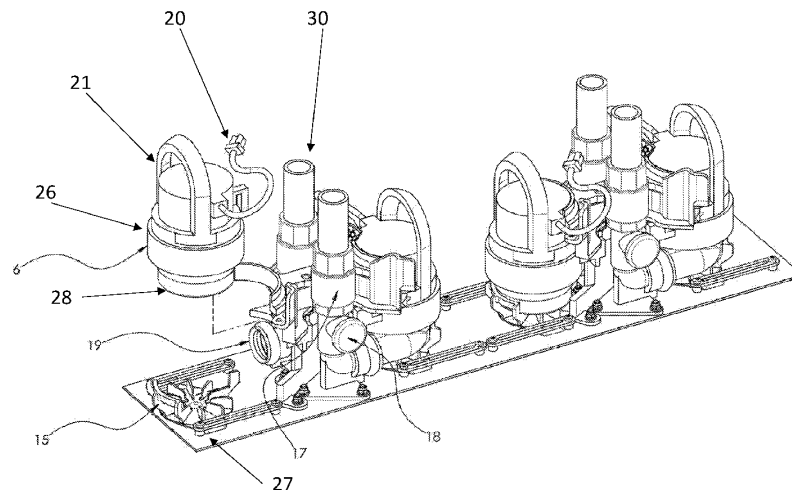


Figure 5B

(57) Abstract: A pump docking assembly is configured to interconnect at least one pump with a coolant liquid flow loop. The pump docking assembly comprises: at least one pump receiving device arranged to releasably engage with the at least one pump; and a coolant liquid flow loop port connectable to the at least one pump. The at least one pump includes a liquid coolant inlet. A liquid cooling chassis housing encloses at least one electronic component and comprises a liquid coolant distribution device interconnecting a liquid coolant flow loop with the pump docking assembly.

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